



PWM Control 3A Step-Down Converter

❖ GENERAL DESCRIPTION

AX3102 consists of step-down switching regulator with PWM control. These devise include a reference voltage source, oscillation circuit, error amplifier, internal PMOS and etc.

AX3102 provides low-ripple power, high efficiency, and excellent transient characteristics. The PWM control circuit is able to every the duty ratio linearly form 0 up to 100%. This converter also contains an error amplifier circuit as well as a soft-start circuit that prevents overshoot at startup. An enable function, an over current protect function and short circuit protect function are built inside, and when OCP or SCP happens, the operation frequency will be reduced. Also, an internal compensation block is built in to minimum external component count.

With the addition of an internal P-channel Power MOS, a coil, capacitors, and a diode connected externally, these ICs can function as step-down switching regulators. They serve as ideal power supply units for portable devices when coupled with the SOP-8L package, providing such outstanding features as low current consumption. Since this converter can accommodate an input voltage up to 23V, it is also suitable for the operation via an AC adapter.

FEATURES

Input voltage: 3.6V to 23V Output voltage: 0.8V to V_{CC}

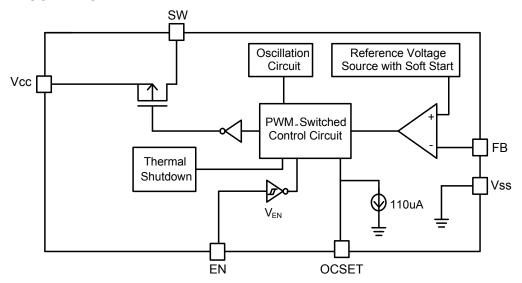
Duty ratio: 0% to 100% PWM control

Oscillation frequency: 330KHz typ.

- Soft-Start (SS), Current Limit (CL), Enable function.
- Thermal Shutdown function.
- Short Circuit Protect (SCP).
- Built-in internal SW P-channel MOS.
- SOP-8L Pb-Free package.

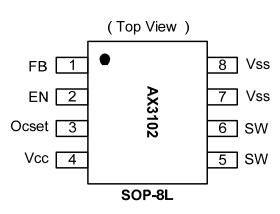


❖ BLOCK DIAGRAM



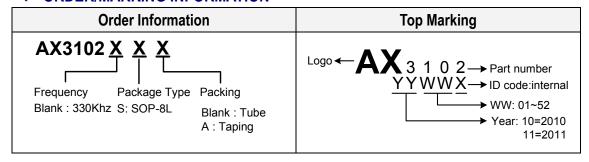
❖ PIN ASSIGNMENT

The package of AX3102 is SOP-8L; the pin assignment is given by:



Name	Description			
FB	Feedback pin			
EN	Power-off pin H: normal operation(Step-down) L: Step-down operation stopped (All circuits deactivated)			
OCSET	Add an external resistor to set max switch output current.			
Vcc	IC power supply pin			
SW	Switch pin. Connect external inductor & diode here.			
Vss	GND pin			

❖ ORDER/MARKING INFORMATION



❖ ABSOLUTE MAXIMUM RATINGS (at T_A=25°C)

Characteristics	Symbol	Rating	Unit
VCC Pin Voltage	Vcc	V_{SS} - 0.3 to V_{SS} + 25	V
Feedback Pin Voltage	V_{FB}	V_{SS} - 0.3 to V_{CC}	V
ON/OFF Pin Voltage	V_{EN}	V_{SS} - 0.3 to V_{CC} + 0.3	V
Switch Pin Voltage	V_{SW}	V_{SS} - 0.3 to V_{CC} + 0.3	V
Power Dissipation	PD	Internally limited	mW
Storage Temperature Range	T _{ST}	-40 to +150	Ŝ
Operating Junction Temperature Range	TJ	-20 to +125	Ŝ
Operating Supply Voltage	V_{OP}	+3.6 to +23	V
Thermal Resistance from Junction to case	$\theta_{ m JC}$	25	°C/W
Thermal Resistance from Junction to ambient	θ_{JA}	70	°C/W

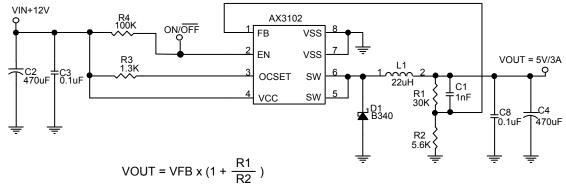
Note: θ_{JA} is measured with the PCB copper area(need connect to SW pins) of approximately 1 in²(Multi-layer).

*** ELECTRICAL CHARACTERISTICS**

(V_{IN} = 12V, V_{OUT}=3.3V, T_A=25°C, unless otherwise specified)

Characteristics	Characteristics Symbol Conditions		Min	Тур	Max	Units
Feedback Voltage	V_{FB}	I _{OUT} =0.1A	0.784	8.0	0.816	V
Quiescent Current	Iccq	V _{FB} =1.2V force driver off	-	3	5	mA
Feedback Bias Current	I _{FB}	I _{OUT} =0.1A	-	0.1	0.5	uA
Shutdown Supply Current	I _{SD}	V _{EN} =0V	-	2	10	uA
OCSET pin bias current	I _{OCSET}		110	130	150	uA
Switch Current	I _{SW}		4.0	-	-	Α
Line Regulation	△Vоит/Vоит	V _{OUT} V _{CC} = 8V~23V, I _{OUT} =0.2A		1	2	%
Load Regulation	△V _{OUT} /V _{OUT} I _{OUT} = 0.1 to 3A		-	0.2	0.5	%
Oscillation Frequency	Oscillation Frequency F _{OSC} SW pin		260	330	400	KHz
EN Pin Logic input threshold	V _{SH}	High (regulator ON)	2.0	-	-	V
voltage	V _{SL}	Low (regulator OFF)	-	-	8.0	V
CN Din Innut Current	I _{SH}	V _{EN} =2.5V (ON)	-	20	-	uA
EN Pin Input Current	I _{SL}	V _{EN} =0.3V (OFF)	-	-10	-	uA
Soft-Start Time	T _{SS}		0.3	4	8	ms
Internal MOSEET D	Б	V _{CC} =5V, V _{FB} =0V	-	90	140	m0
Internal MOSFET R _{DSON}	R _{DSON}	V _{CC} =12V, V _{FB} =0V	-	55	90	mΩ
Efficiency	EFFI	$V_{CC} = 12V$, $I_{OUT} = 2A$		92		%
Efficiency		$V_{OUT} = 5V$ $I_{OUT} = 3A$	-	91	-	70

❖ APPLICATION CIRCUIT



VFB = 0.8V; R2 suggest 0.8K ~ 6k

L1 recommend value (V _{IN} =12V)					
Vout	1.8 V	2.5V	3.3V	5V	
I _{OUT} =3A	12uH	15uH	18uH	22uH	

FUNCTION DESCRIPTIONS

PWM Control

The AX3102 consists of DC/DC converters that employ a pulse-width modulation (PWM) system. In converters of the AX3102, the pulse width varies in a range from 0 to 100%, according to the load current. The ripple voltage produced by the switching can easily be removed through a filter because the switching frequency remains constant. Therefore, these converters provide a low-ripple power over broad ranges of input voltage and load current.

RDS (ON) Current Limiting

The current limit threshold is setting by the external resistor (R3) connecting from V_{CC} supply to OCSET pin. The internal 130uA sink current crossing the resistor sets the voltage at pin of OCSET. When the PWM voltage is less than the voltage at OCSET, an over-current condition is triggered. Please refer to the formula for setting the current limit value:

$$I_{SW(MAX)} = \frac{I_{OCSET} \times R3 + 0.095}{R_{DS(ON)}}$$

(Normally, The $I_{SW(MAX)}$ setting more than I_{OUT} 1.0A).

Example:

$$I_{SW}$$
 = (0.13uA x 1.3k + 0.095)/ 0.055=4.8A
 I_{SW} = (0.13x 1.3 + 0.095)/ 0.055= 4.8A

Setting the Output Voltage

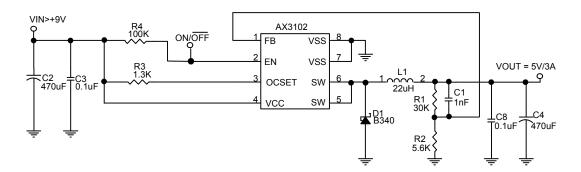
Application circuit item shows the basic application circuit with AX3102 adjustable output version. The external resistor sets the output voltage according to the following equation:

$$V_{OUT} = 0.8V \times \left(1 + \frac{R1}{R2}\right)$$

Table 1 Resistor select for output voltage setting

R2	R1
1.3K	6.8K
5.6K	30K
1.5K	4.7K
5.6K	18K
2.2K	4.7K
5.6K 1.5K 5.6K 2.2K 5.6K 2K 2.2K 3K	12K
2K	2.5K
2.2K	2.0K
3K	1.5K
3K	0.75K
	1.3K 5.6K 1.5K 5.6K 2.2K 5.6K 2K 2.2K 3K

R2 setting 5.6k that System Operation Current (No load) can be reduce to under 4mA.



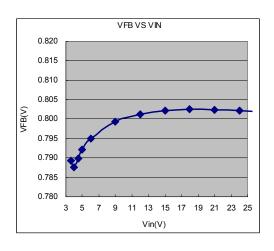
PCB Layout Guide

If you need low Tc and Tj or large PD (Power Dissipation), the dual SW pins (5 and 6) on the SOP-8L package are internally connected to die pad, The PCB layout should allow for maximum possible copper area at the SW pins.

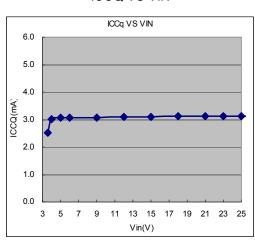
- 1. Connect C3 to V_{CC} pin as closely as possible to get good power filter effect.
- 2. Connect R3 to V_{CC} pin as closely as possible.
- 3. Connect ground side of the C2 and D1 as closely as possible.

TYPICAL CHARACTERISTICS

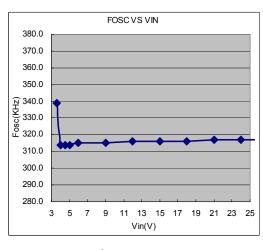
VFB VS VIN



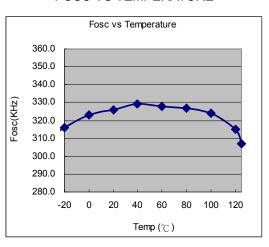
ICCQ VS VIN



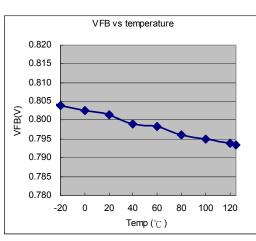
FOSC VS VIN



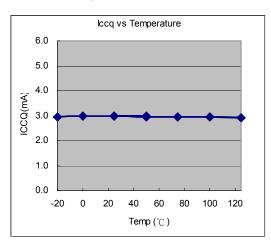
FOSC VS TEMPERATURE



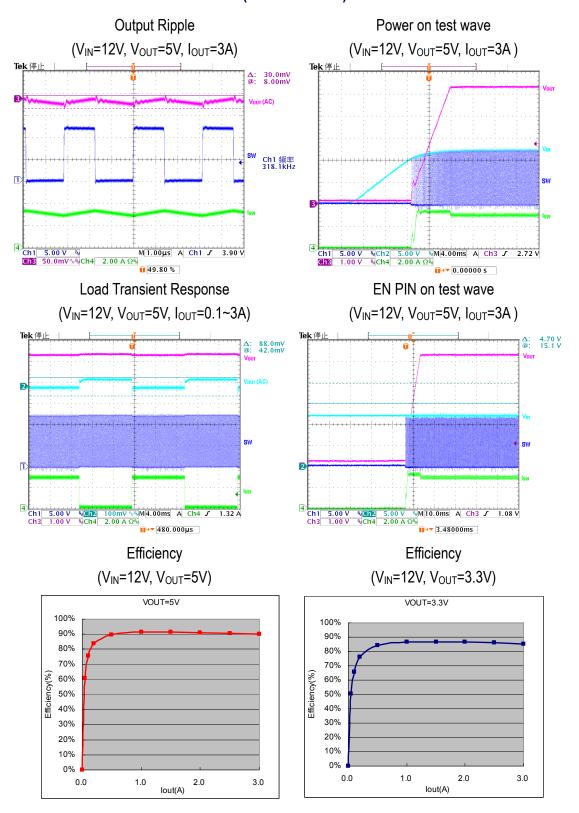
VFB VS TEMPERATURE



ICCQ VS TEMPERATURE

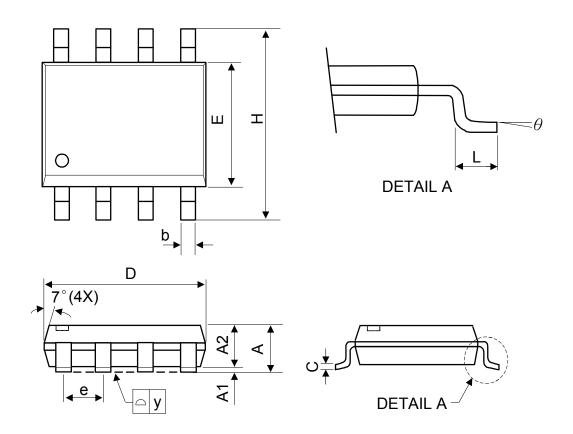


TYPICAL CHARACTERISTICS (CONTINUOUS)





PACKAGE OUTLINES



Symbol	Dimensions in Millimeters			Dimensions in Inches			
	Min.	Nom.	Max.	Min.	Nom.	Max.	
А	-	-	1.75	-	-	0.069	
A1	0.1	-	0.25	0.04	-	0.1	
A2	1.25	-	-	0.049	-	-	
С	0.1	0.2	0.25	0.0075	0.008	0.01	
D	4.7	4.9	5.1	0.185	0.193	0.2	
Е	3.7	3.9	4.1	0.146	0.154	0.161	
Н	5.8	6	6.2	0.228	0.236	0.244	
L	0.4	-	1.27	0.015	-	0.05	
b	0.31	0.41	0.51	0.012	0.016	0.02	
е	1.27 BSC			(0.050 BSC	·	
у	-	-	0.1	-	-	0.004	
θ	00	-	8 0	00	-	8 0	

Mold flash shall not exceed 0.25mm per side

JEDEC outline: MS-012 AA